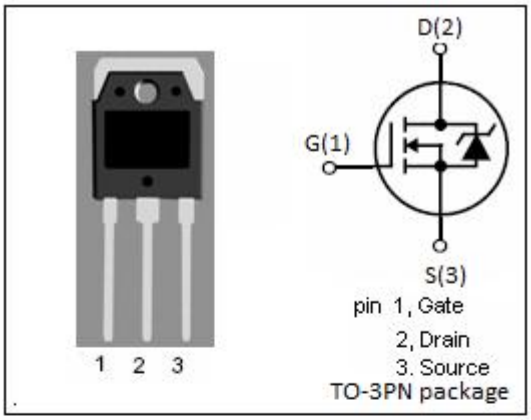
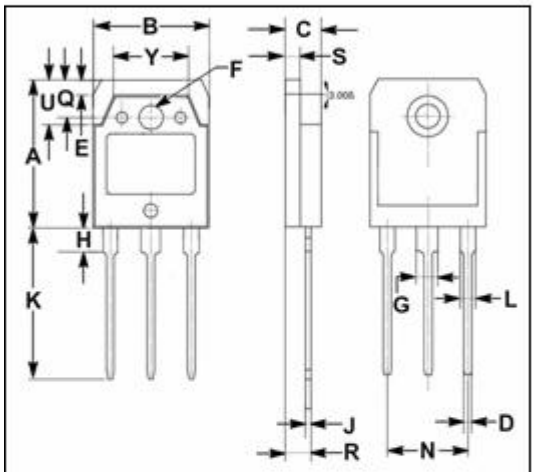
isc N-Channel MOSFET Transistor 6N80



- **FEATURES**
- Drain Current I_D= 6A@ T_C=25℃
- Drain Source Voltage
  : V_{DSS}= 800V(Min)
- Static Drain-Source On-Resistance
  : $R_{DS(on)}$ = 2Ω(Max)
- Avalanche Energy Specified
- Fast Switching
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

- **DESCRITION**.

Switch-mode and resonant-mode
Power supplies
Motor controls
Uninterruptible Power Supplies (UPS)
DC choppers



DIM	mm MIN	MAX
A	19.60	20.30
B	15.50	15.70
C	4.70	4.90
D	0.90	1.10
E	1.90	2.10
F	3.40	3.60
G	2.90	3.20
H	3.20	3.40
J	0.595	0.605
K	19.80	20.70
L	1.90	2.20
N	10.89	10.91
Q	4.90	5.10
R	3.35	3.45
S	1.995	2.100
U	5.90	6.20
Y	9.90	10.10

- **ABSOLUTE MAXIMUM RATINGS(T_a=25℃)**

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	800	V
V_{GS}	Gate-Source Voltage-Continuous	±20	V
I_D	Drain Current-Continuous	6	A
I_{DM}	Drain Current-Single Plused	24	A
P_D	Total Dissipation @T_C=25℃	150	W
T_j	Max. Operating Junction Temperature	150	℃
T_{stg}	Storage Temperature	-55~150	℃

- **THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	MAX	UNIT
$R_{th\ j\text{-}c}$	Thermal Resistance, Junction to Case	0.83	℃/W
$R_{th\ j\text{-}a}$	Thermal Resistance, Junction to Ambient	40	℃/W

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ELECTRICAL CHARACTERISTICS

T_C=25℃ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}= 0; I_D=250μA	800			V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}= V_{GS}; I_D=250μA	2.0		4.0	V
V_{SD}	Diode Forward On-voltage	I_S= 10A ;V_{GS}= 0			1.5	V
$R_{DS(on)}$	Drain-Source On-Resistance	V_{GS}= 10V; I_D= 0.85A			1.2	Ω
I_{GSS}	Gate-Body Leakage Current	V_{GS}= ±20V;V_{DS}= 0			±100	nA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=800V; V_{GS}= 0			250	μA
t_r	Rise Time	V_{GS}=10V; I_D=3A; V_{DD}=400V; R_L=2Ω			110	ns
$t_{d(on)}$	Turn-on Delay Time				100	
t_f	Fall Time				100	
$t_{d(off)}$	Turn-off Delay Time				200	